

DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION

(X) Original () Supplemental () Substitute () PCT () DESIGN

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

Title: A SEMICONDUCTOR LASER DEVICE AND A METHOD OF MOUNTING A SEMICONDUCTOR LASER COMPONENT ON A SUBMOUNT

of which is described and claimed in:

() the attached specification, or

(X) the specification in application Serial No. _____, filed July 30, 2003, and with amendments through _____, or

() the specification in International Application No. _____, filed _____, and as amended on _____ (if applicable).

I hereby state that I have reviewed and understand the content of the above-identified specification, including the claims, as amended by any amendment(s) referred to above.

I acknowledge my duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I hereby claim priority benefits under Title 35, United States Code, §119 (and §172 if this application is for a Design) of any application(s) for patent or inventor's certificate listed below and have also identified below any application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

COUNTRY	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED
Japan	P2001-008483	January 17, 2001	NO

I hereby claim the benefit under Title 35, United States Code §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

APPLICATION SERIAL NO.	U.S. FILING DATE	STATUS: PATENTED, PENDING, ABANDONED

And I hereby appoint Michael R. Davis, Reg. No. 25,134; Matthew M. Jacob, Reg. No. 25,154; Warren M. Cheek, Jr., Reg. No. 33,367; Nils Pedersen, Reg. No. 33,145; Charles R. Watts, Reg. No. 33,142; Michael S. Huppert, Reg. No. 40,268; and Jeffrey R. Filipek, Reg. No. 41,471, who together constitute the firm of WENDEROTH, LIND & PONACK, L.L.P., as well as any other

attorneys and agents associated with Customer No. 000513, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith.

I hereby authorize the U.S. attorneys and agents named herein to accept and follow instructions from AOYAMA & PARTNERS as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

Direct Correspondence to: <div style="text-align: center; margin-top: 20px;"> CUSTOMER NO. 000513 </div>	Direct Telephone Calls to: <div style="text-align: center; margin-top: 10px;"> WENDEROTH, LIND & PONACK, L.L.P. 2033 "K" Street, N.W., Suite 800 Washington, D.C. 20006-1021 Phone: (202) 721-8200 Fax: (202) 721-8250 </div>
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Full Name of First Inventor	FAMILY NAME MOCHIDA	FIRST GIVEN NAME Atuhito	SECOND GIVEN NAME
Residence & Citizenship	CITY Shizuoka-shi	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 24-4, Oiawahonmachi, Shizuoka-shi, Shizuoka	CITY 420-0884	STATE OR COUNTRY Japan

Full Name of Second Inventor	FAMILY NAME INOUE	FIRST GIVEN NAME Hiroto	SECOND GIVEN NAME
Residence & Citizenship	CITY Hirakata-shi	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 20-1-1021, Higashinakaburi 2-chome, Hirakata-shi, Osaka	CITY 573-0093	STATE OR COUNTRY Japan

Full Name of Third Inventor	FAMILY NAME NAKAO	FIRST GIVEN NAME Suguru	SECOND GIVEN NAME
Residence & Citizenship	CITY Itami-shi	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 606, Sentoraru-Shinitami, 1-4-1, Misuzu-cho, Itami-shi, Hyogo	CITY 661-0884	STATE OR COUNTRY Japan

Full Name of Fourth Inventor	FAMILY NAME IWATA	FIRST GIVEN NAME Yukihiro	SECOND GIVEN NAME
Residence & Citizenship	CITY Ibaragi-shi	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 7-9-401, Yamatedai 4-chome, Ibaragi-shi, Osaka	CITY 567-0009	STATE OR COUNTRY Japan

Full Name of Fifth Inventor	FAMILY NAME TAKAMORI	FIRST GIVEN NAME Akira	SECOND GIVEN NAME
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Residence & Citizenship	CITY Suita-shi	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 35-1-406, Yamadahigashi 4-chome, Suita-shi, Osaka	CITY Suita-shi	STATE OR COUNTRY Osaka
Full Name of Sixth Inventor	FAMILY NAME ADACHI	FIRST GIVEN NAME Hideto	SECOND GIVEN NAME
Residence & Citizenship	CITY Okayama-shi	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 338-B102, Higashikawahara, Okayama-shi, Okayama	CITY Okayama-shi	STATE OR COUNTRY Okayama
Full Name of Seventh Inventor	FAMILY NAME TAMURA	FIRST GIVEN NAME Masatoshi	SECOND GIVEN NAME
Residence & Citizenship	CITY Takatsuki-shi	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 2-8, Sachimachi, Takatsuki-shi, Osaka	CITY Takatsuki-shi	STATE OR COUNTRY Osaka

I further declare that all statements made herein of my own knowledge are true, and that all statements on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

1st Inventor _____ Date _____
Atuhito MOCHIDA

2nd Inventor _____ Date _____
Hiroto INOUE

3rd Inventor _____ Date _____
Suguru NAKAO

4th Inventor _____ Date _____
Yukihiro IWATA

5th Inventor _____ Date _____
Akira TAKAMORI

6th Inventor _____ Date _____
Hideto ADACHI

7th Inventor _____ Date _____
Masatoshi TAMURA

The above application may be more particularly identified as follows:

U.S. Application Serial No. _____ Filing Date July 30, 2003

Applicant Reference Number 538061 Atty Docket No. 2003-1070A

Title of Invention A SEMICONDUCTOR LASER DEVICE AND A METHOD OF MOUNTING A SEMICONDUCTOR LASER COMPONENT ON A SUBMOUNT